IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Joseph E. Geusic et al.

Title:

USING OPTICAL FIBER INTERCONNECTS **FORMED** INTEGRATED CIRCUITS

THROUGH A SEMICONDUCTOR WAFER

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Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

A return postcard.

A Response to Restriction Requirement (1 Page).

A Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this Z3 day of November, 2004.

Name

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(GENERAL)